



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| Device | BV _{DSS} | R _{DS(ON)} max | I _D max T _A = +25°C |
|---------|-------------------|-------------------------------|--|
| N- | 2017 | 0.4Ω @ V _{GS} = 10V | 0.8A |
| Channel | 30V | 0.7Ω @ V _{GS} = 4.5V | 0.57A |

Features and Benefits

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- **Power Management Functions**
- DC-DC Converters

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.027 grams (Approximate)

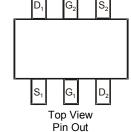


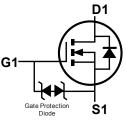


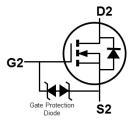
Top View

SOT363









Q1 N-Channel Q2 N-Channel

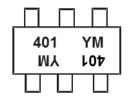
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|--------|-------------------|
| DMN3401LDW-7 | SOT363 | 3000/Tape & Reel |
| DMN3401LDW-13 | SOT363 | 10000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



401 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} or \underline{Y} = Year (ex: \overline{I} = 2021) M = Month (ex: 9 = September)

Date Code Key

| Date Code Ney | | | | | | | | | | | | |
|---------------|------|-----|------|------|------|------|------|------|------|------|------|------|
| Year | 2018 | | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 |
| Code | F | | I | J | K | L | М | N | 0 | Р | R | S |
| | | | | | | | | | | | | |
| | • | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



Notes:

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|---|----------------|---------------------|-----------------|---|---|
| Drain-Source Voltage | V_{DSS} | V _{DSS} 30 | | | |
| Gate-Source Voltage | V_{GSS} | ±20 | V | | |
| Continuous Drain Current (Note 6) V _{GS} = 10V | l _D | 0.8 0.6 | Α | | |
| Maximum Continuous Body Diode Forward Current | Is | 0.4 | Α | | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1% | o) | | I _{DM} | 4 | Α |

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--|-------------------|------------------|-------|------|
| Total Power Dissipation (Note 5) | | P_{D} | 0.29 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $R_{\theta JA}$ | 433 | °C/W |
| Total Power Dissipation (Note 6) | | P_{D} | 0.35 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | R _{0JA} | 360 | °C/W |
| Operating and Storage Temperature Range | $T_{J_i} T_{STG}$ | -55 to +150 | °C | |

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

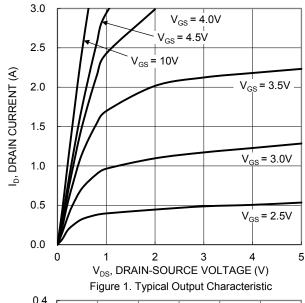
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

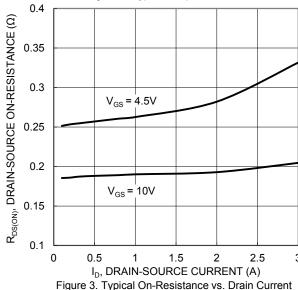
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|------|-----|------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1.0 | μΑ | $V_{DS} = 30V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | | _ | ±10 | μΑ | $V_{GS} = \pm 20V$, $V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | 8.0 | 1.2 | 1.6 | V | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | |
| Static Drain-Source On-Resistance | D | _ | 0.2 | 0.4 | Ω | $V_{GS} = 10V, I_D = 0.59A$ | |
| Static Dialii-Source Oil-Resistance | R _{DS(ON)} | _ | 0.3 | 0.7 | 12 | $V_{GS} = 4.5V$, $I_D = 0.2A$ | |
| Diode Forward Voltage | V_{SD} | _ | 0.7 | 1.2 | V | $V_{GS} = 0V, I_{S} = 10mA$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | C _{iss} | _ | 50 | _ | pF | 15)/)/ | |
| Output Capacitance | Coss | _ | 12 | _ | pF | V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz | |
| Reverse Transfer Capacitance | Crss | | 10 | | pF | 1 - 1:001112 | |
| Gate Resistance | R_g | | 58 | | Ω | $V_{DS} = V_{GS} = 0V$, $f = 1.0MHz$ | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 0.5 | | nC | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | _ | 1.2 | _ | nC | V _{DS} = 10V, V _{GS} = 10V | |
| Gate-Source Charge | Q_{gs} | _ | 0.2 | _ | nC | I _D = 250mA | |
| Gate-Drain Charge | Q_{gd} | _ | 0.1 | | nC | | |
| Turn-On Delay Time | t _{D(ON)} | _ | 3.5 | _ | ns | | |
| Turn-On Rise Time | t _R | _ | 3.3 | _ | ns | $V_{GS} = 10V, V_{DS} = 30V,$ | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 16.8 | _ | ns | $I_D = 100 \text{mA}, R_G = 25 \Omega$ | |
| Turn-Off Fall Time | t_{F} | | 13.8 | _ | ns | | |

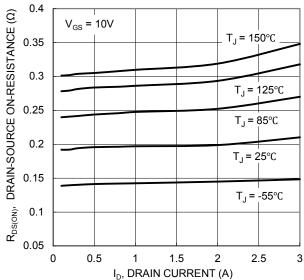
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



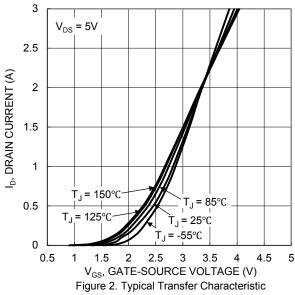


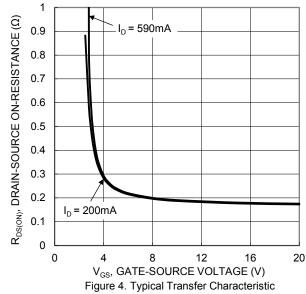




and Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





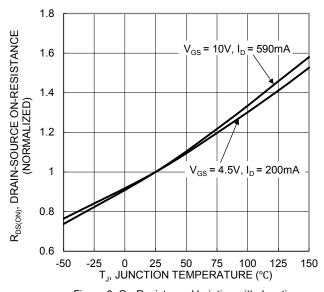


Figure 6. On-Resistance Variation with Junction Temperature





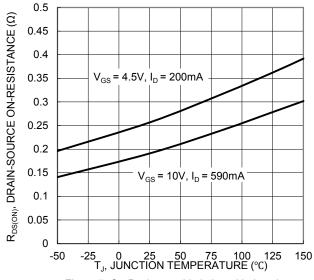
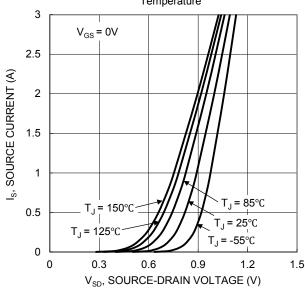


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

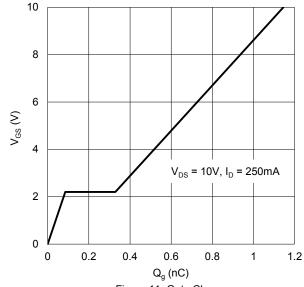


Figure 11. Gate Charge

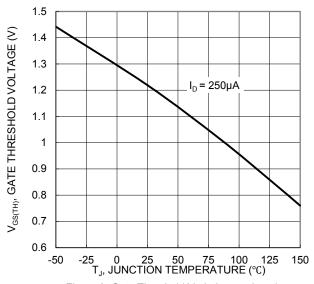
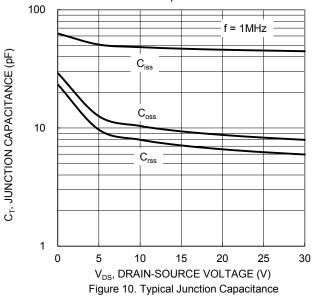
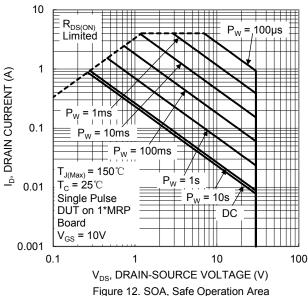


Figure 8. Gate Threshold Variation vs. Junction Temperature







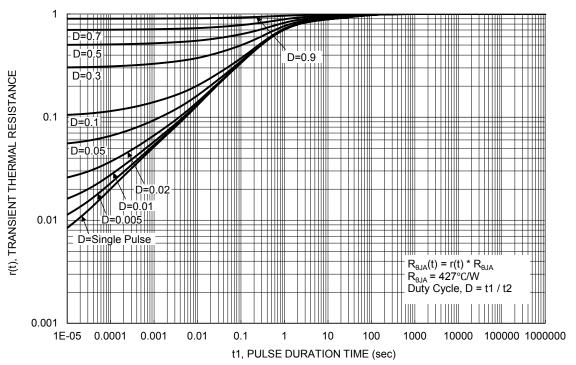


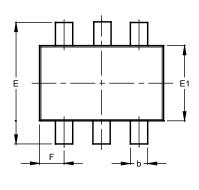
Figure 13. Transient Thermal Resistance

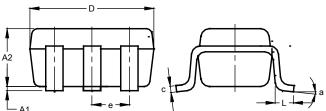


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



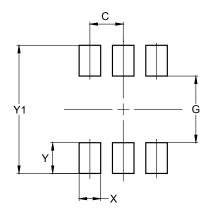


| SOT363 | | | | | | | |
|----------------------|-------------|--------|-------|--|--|--|--|
| Dim | Min Max Typ | | | | | | |
| A1 | 0.00 | 0.10 | 0.05 | | | | |
| A2 | 0.90 | 1.00 | 0.95 | | | | |
| b | 0.10 | 0.30 | 0.25 | | | | |
| С | 0.10 | 0.22 | 0.11 | | | | |
| D | 1.80 | 2.20 | 2.15 | | | | |
| Е | 2.00 | 2.20 | 2.10 | | | | |
| E1 | 1.15 | 1.35 | 1.30 | | | | |
| е | O | .650 E | SC | | | | |
| F | 0.40 | 0.45 | 0.425 | | | | |
| L | 0.25 | 0.40 | 0.30 | | | | |
| а | 0° | 8° | | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



| Dimensions | Value |
|------------|---------|
| Dimensions | (in mm) |
| С | 0.650 |
| G | 1.300 |
| Х | 0.420 |
| Υ | 0.600 |
| Y1 | 2.500 |



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